

standard 1A TRIACS

Table 1: Main Features

Symbol	Value	Unit
I _{T(RMS)}	1	Α
V _{DRM} /V _{RRM}	600 to 800	V
I _{GT (Q₁)}	3 to 25	mA

DESCRIPTION

The Z01 series is suitable for general purpose AC switching applications. They can be found in applications such as home appliances (electrovalve, pump, door lock, small lamp control), fan speed controllers,...

Different gate current sensitivities are available, allowing optimized performances when controlled directly from microcontrollers.

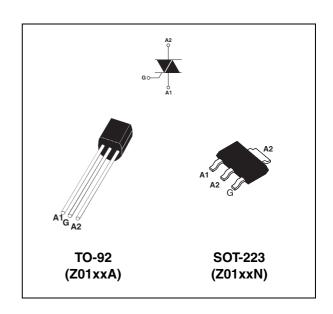


Table 2: Order Codes

Part Number	Marking
Z01xxA	See page table 8 on
Z01xxN	page 7

Table 3: Absolute Maximum Ratings

Symbol	Paramet	Parameter				
l_,_,,	RMS on-state current	RMS on-state current SOT-223 $T_{tab} = 90^{\circ}C$		1	Α	
I _{T(RMS)}	(full sine wave)	TO-92	T _L = 50°C	ı	A	
I _{TSM}	Non repetitive surge peak on-state	F = 50 Hz	t = 20 ms	8	Α	
'ISM	current (full cycle, T_j initial = 25°C)	F = 60 Hz	t = 16.7 ms	8.5	Α	
l ² t	I ² t Value for fusing	Value for fusing $t_p = 10 \text{ ms}$		0.35	A ² s	
dI/dt	Critical rate of rise of on-state current $I_G = 2 \times I_{GT}$, $t_r \le 100 \text{ ns}$	F = 120 Hz	T _j = 125°C	20	A/µs	
I _{GM}	Peak gate current $t_p = 20 \mu s$ $T_j =$		T _j = 125°C	1	Α	
P _{G(AV)}	Average gate power dissipation $T_j = 125^{\circ}C$			1	W	
T _{stg} T _j	Storage junction temperature range Operating junction temperature range			- 40 to + 150 - 40 to + 125	°C	

Tables 4: Electrical Characteristics ($T_j = 25$ °C, unless otherwise specified)

Symbol	Test Conditions	Quadrant			Z	01		Unit
- Cymboi	rest conditions	Quadrant		03	07	09	10	Oilit
I _{GT} (1)	$V_D = 12 \text{ V} R_L = 30 \Omega$	I - II - III - IV	MAX.	3 5	5 7	10 10	25 25	mA
V _{GT}		ALL	MAX.		1.3			V
V _{GD}	$V_D = V_{DRM}$ $R_L = 3.3 \text{ k}\Omega$ ALL		MIN.	0.2				V
I _H (2)	I _T = 50 mA		MAX.	7	10	10	25	mA
l _l	l _G = 1.2 l _{GT}	I - III - IV	MAX.	7	10	15	25	mA
, .r.	·G ··= ·G	II	IVI/-VX.	15	20	25	50	ША
dV/dt (2)	V _D = 67 %V _{DRM} gate open T _j = 110°C		MIN.	10	20	50	100	V/µs
(dl/dt)c (2)	$(dV/dt)c = 0.44 \text{ A/ms} T_j = 11$	0°C	MIN.	0.5	1	2	5	A/ms

Table 5: Static Characteristics

Symbol	Test C		Value	Unit	
V _{TM} (2)	$I_{TM} = 1.4 \text{ A}$ $t_p = 380 \mu\text{s}$	T _j = 25°C	MAX.	1.56	V
V _{to} (2)	Threshold voltage $T_j = 125^{\circ}C$		MAX.	0.95	V
R _d (2)	Dynamic resistance $T_j = 125$ °C MAX.		MAX.	400	mΩ
I _{DRM}	$V_{DRM} = V_{RRM}$	T _j = 25°C	MAX.	5	μA
I _{RRM}	*DRIM - *RRIM	T _j = 125°C			mA

Note 1: minimum I_{GT} is guaranted at 5% of I_{GT} max. Note 2: for both polarities of A2 referenced to A1.

Table 6: Thermal resistances

Symbol	Parameter			Value	Unit
R _{th(j-t)}	Junction to tab (AC)		SOT-223	25	°C/W
R _{th(j-l)}	Junction to lead (AC)		TO-92	60	0/ **
R _{th(j-a)}	Junction to ambient	$S = 5 \text{ cm}^2$	SOT-223	60	°C/W
· · · · · · · · · · · · · · · · · · ·			TO-92	150	0,11

S = Copper surface under tab.

Figure 1: Maximum power dissipation versus RMS on-state current (full cycle)

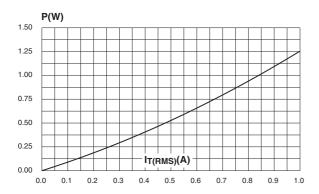


Figure 3: RMS on-state current versus ambient temperature (full cycle)

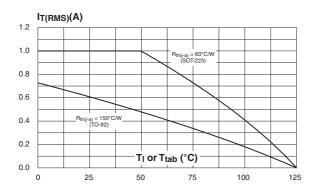


Figure 5: Relative variation of gate trigger current, holding current and latching current versus junction temperature (typical values)

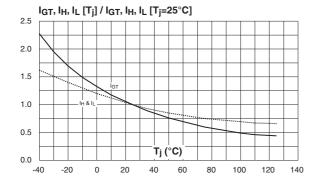


Figure 2: RMS on-state current versus case temperature (full cycle)

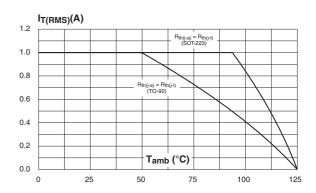


Figure 4: Relative variation of thermal impedance versus pulse duration

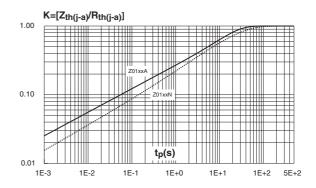


Figure 6: Surge peak on-state current versus number of cycles

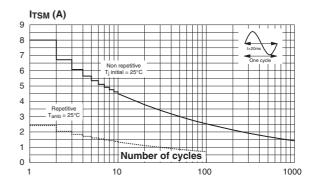


Figure 7: Non-repetitive surge peak on-state current for a sinusoidal pulse with width $t_{\rm p}$ < 10 ms and corresponding value of l^2t

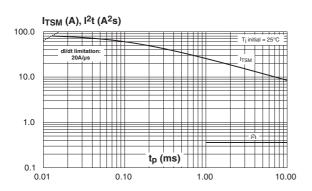


Figure 9: Relative variation of critical rate of decrease of main current versus (dV/dt)c (typical values)

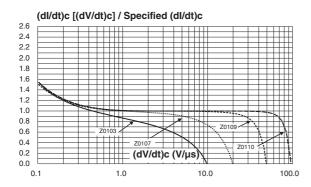


Figure 11: SOT-223 Thermal resistance junction to ambient versus copper surface under tab (printed circuit board FR4, copper thickness: $35 \, \mu m$)

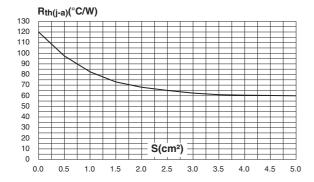


Figure 8: On-state characteristics (maximum values)

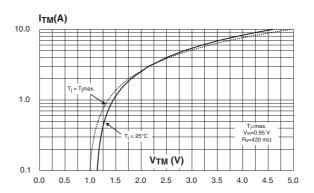
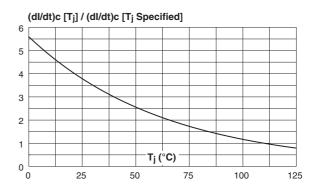


Figure 10: Relative variation of critical rate of decrease of main current versus junction temperature



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Figure 12: Ordering Information Scheme

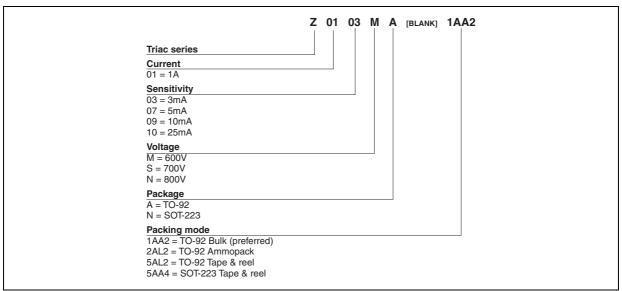


Table 7: Product Selector

Don't Novelle or	Voltage Voltage		0 111-11	T		
Part Number	600 V	700 V	800 V	Sensitivity	Туре	Package
Z0103MA	Х			3 mA	Standard	TO-92
Z0103MN	Х			3 mA	Standard	SOT-223
Z0103SA		Х		3 mA	Standard	TO-92
Z0103SN		Х		3 mA	Standard	SOT-223
Z0103NA			Х	3 mA	Standard	TO-92
Z0103NN			Х	3 mA	Standard	SOT-223
Z0107MA	Х			5 mA	Standard	TO-92
Z0107MN	Х			5 mA	Standard	SOT-223
Z0107SA		Х		5 mA	Standard	TO-92
Z0107SN		Х		5 mA	Standard	SOT-223
Z0107NA			Х	5 mA	Standard	TO-92
Z0107NN			Х	5 mA	Standard	SOT-223
Z0109MA	Х			10 mA	Standard	TO-92
Z0109MN	Х			10 mA	Standard	SOT-223
Z0109SA		Х		10 mA	Standard	TO-92
Z0109SN		Х		10 mA	Standard	SOT-223
Z0109NA			Х	10 mA	Standard	TO-92
Z0109NN			Х	10 mA	Standard	SOT-223
Z0110MA	Х			25 mA	Standard	TO-92
Z0110MN	Х			25 mA	Standard	SOT-223
Z0110SA		Х		25 mA	Standard	TO-92
Z0110SN		Х		25 mA	Standard	SOT-223
Z0110NA			Х	25 mA	Standard	TO-92
Z0110NN			Х	25 mA	Standard	SOT-223



Figure 13: SOT-223 Package Mechanical Data

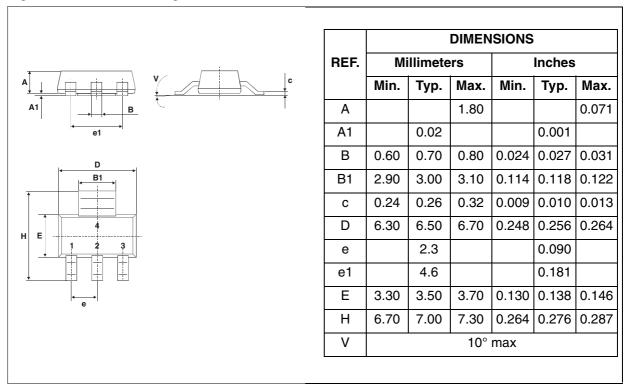
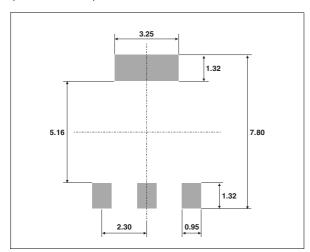
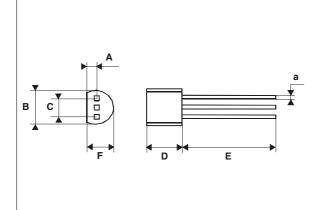


Figure 14: SOT-223 Foot Print Dimensions (in millimeters)



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Figure 15: TO-92 Package Mechanical Data



		DIMENSIONS						
REF.	Mi	Millimeters			Inches			
	Min.	Тур.	Max.	Min.	Тур.	Max.		
Α		1.35			0.053			
В			4.70			0.185		
С		2.54			0.100			
D	4.40			0.173				
Е	12.70			0.500				
F			3.70			0.146		
а			0.50			0.019		

Table 8: Ordering Information

Ordering type	Marking	Weight	Base quantity	Delivery mode
Z01xxyA 1AA2	Z01xxyA	0.2 g	2500	Bulk
Z01xxyA 2AL2	Z01xxyA	0.2 g	2000	Ammopack
Z01xxyA 5AL2	Z01xxyA	0.2 g	2000	Tape & reel
Z0103yN 5AA4	Z3y	0.12 g	1000	Tape & reel
Z0107yN 5AA4	Z7y	0.12 g	1000	Tape & reel
Z0109yN 5AA4	Z9y	0.12 g	1000	Tape & reel

Note: xxx = sensitivity, y = voltage

Table 9: Revision History

Date	Revision	Description of Changes
Oct-2001	4	Last update.
10-Feb-2005	5	Package: TO-92 tape & reel delivery mode 5AL2 added.

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